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MOHAMMED BIN RASHID SPACE CENTRE

# Payload Hosting Initiative (PHI)

## **PHI Platform User Guide**



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## **1.0 SCOPE**

This document developed by the Mohammed Bin Rashid Space Centre (MBRSC), aims to provide insights into the capabilities of the PHI platform and outline its modular specifications. Applicants interested in hosting their payloads on the PHI platform should ensure that their interfaces are compatible in accordance with the guidelines presented in this document.

## **2.0 OVERVIEW**

The Mohammed Bin Rashid Space Center (MBRSC) in Dubai, the United Arab Emirates (UAE), is soliciting proposal from relevant companies, universities, and research centers worldwide to provide new technologies as hosted payloads for an upcoming Payload Hosting Initiative (PHI) mission. The Mohammed Bin Rashid Space Center was established by Decree Number 2 in 2006 by H.H. Shaikh Mohamed Bin Rashed Al Maktoum to inspire scientific innovation, technological advancement, and to advance sustainable development in UAE. As part of this vision, MBRSC is leading the effort to build space innovative technologies to design, manufacture, and test small satellites in short period of time with verifying hosted payloads.

To achieve a successful mission, MBRSC will handle the development; operation and launch of the satellite bus while the hosted payload entity will handle the development and testing of the payload then hand it over to MBRSC to be integrated with PHI platform. Additional information on MBRSC can be found online at <u>www.MBRSC.ae</u>.



## **3.0 PLATFORM GENERAL DESCRIPTION**

The PHI platform design allows for the maximization of volume available for the payload up to five units. The design also ensures robust power properties and various power distribution lines with protection. The satellite has a centralized data system where the OBC will gather all the telemetries via multiple data communication protocols. Also, the platform provides an attitude and control system with a high level of stability and accuracy. The design provides modular data, power and mechanical interfaces between the hosted payloads and the platform. The thermal design of the payloads can be analyzed based on thermal sensitivity and operation of the payloads. Figure (1) shows the general interfaces between all subsystems in the platform. Table (1) shows the general specification of PHI satellite design.



Figure 1: PHI Architecture



Table 1 : Genera	l Specifications
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Specifications	Value
Lifetime	1 year
Orbit Type	Sun Synchronous Orbit
Orbit Altitude	500 Km - 600 Km
Satellite Mass	18Kg
Power Generation	38W
Bus Voltage	14.8V
Communication Bands	UHF, VHF, S-band
Downlink Data Rate	9.6kbps to 1Mbps
Control Accuracy	5 deg
Data Interface	I2C, CAN, UART, SPI

## 4.0 SATELLITE BUS DESIGN AND INTERFACES

## 4.1 Electrical Power Interface

The Electrical Power Subsystem (EPS) is a high-power modular system designed by MBRSC. It comprises a module for power charging and control, along with modules for power distribution that incorporate protective features, all designed with the following specifications:

- Unregulated voltage rail: 13.0 ~ 16.4V
- Output channels:
  - Up to 6A output current for 13.0 ~ 16.4V unregulated voltage lines.
  - Buck regulated power channels.
    - Up to 3A output current for 3.3V switch lines (2 lines reserved for payloads).
    - Up to 3A output current for 5V switch lines (2 lines reserved for payloads).
    - Up to 4A output current for 12V switch lines (2 lines reserved for payloads).
  - Over-current and reverse-current protection in hardware



- Over-voltage protections
- Turn on voltage ramp control (soft start)
- Accurate voltage, current and power sensing on each channel

The payload subsystem can be connected to one or multiple switchable power lines depending on their operations. It is recommended to connect each module in the payload subsystem to one switchable power line to control the turn ON/OFF and ensure the protection of the power distribution line supplied from EPS to the payload. The typical power connector and pin allocation through auxiliary connector or PC/104 stacking connector will be agreed later with MBRSC.

The maximum power consumption allocated for the payloads is 30 W for 20 minutes operation per orbit in sunlight. If the payload requires higher power consumption, MBRSC can assess the power budget later and provide higher power consumption depending on mission operations.

## 4.2 Grounding Interface

The platform follows a star grounding scheme where all ground points will be returned to the EPS subsystems. The EPS does not provide secondary ground and isolation for sensitive subsystems. The payload should consider ground isolation from the load side if required.

### 4.3 Data Interface

The satellite bus is a collection of four different buses that connects the different subsystems' interfaces with the main Flight Computer. In the first modular satellite mission, four protocols will be used which are:

1. Inter-Integrated Circuit (I<sup>2</sup>C)

I2C	Min	Typical	Max	Unit
Voltage	0	-	3.3	V
Pull-up resistors	-	2.2	-	kΩ
Frequency	-	100	400	kHz

#### Table 2: I2C specifications



The payload can be connected to  $I^2C$  bus as a slave. The address of the payload will be given later. Pull-up resistor of 2.2 k $\Omega$  is added from master side. Payload shall remove any pull-up resistor from their design to interface with the platform  $I^2C$  bus.

#### 2. Serial Peripheral Interface (SPI)

Table 3: SPI specifications

SPI	Min	Typical	Max	Unit
Voltage	0	-	3.3	V
Frequency	-	187	-	kHz

#### 3. Controller Area Network (CAN)

#### Table 4: CAN specifications

CAN	Min	Typical	Max	Unit
Dominant Differential Output Voltage	1.6	-	3	V
Recessive Differential Output Voltage	-0.05	-	0.1	V
Bitrate	-	125	1000	Kbit/s

The payload can be connected to CAN bus as a slave. The address of the payload will be given later. CAN termination resistor of 120  $\Omega$  is added from master side. Payload shall remove any termination resistor from their design to interface with the platform CAN bus.

The platform provides another option to use the CAN interface to send a CSP packet. The CubeSat Space Protocol is an open-source C-program network layer delivery protocol used for communication between subsystems in small satellites and with ground stations. This protocol is based on a 32-bit header that contains the transport and network layer information.



#### Table 5: CSP packet structure

	Header (4 Bytes)						Data				
Bit	2	5	5	6	6	4	1	1	1	1	1640
Name	Priority	Source	Destination	Destination	Source	Reserved	HMAC	XTEA	RDP	CRC	Data
				Port	Port						

The figure below shows CSP packet over CAN packet structure.



Figure 2: CSP Over CAN Interface Packet Structure

The first CAN packet must include CSP packet header and length of the CSP data. If there is any CSP data, up to 2 bytes of is added to the first CAN data packet. All the other CAN data packets contain only CSP data as shown in the figure above.

4. Universal Asynchronous Transmitter Receiver (UART)

#### Table 6: UART specifications

UART	Min	Typical	Max	Unit
Voltage	0	-	3.3	V
Baud-rate	-	-	12.5	Mbit/s



The platform can provide PPS signal from the GPS. The pin assignment of data lines and PPS that can be provided through PC/104 stacking connector will be agreed later with MBRSC. The typical data auxiliary connectors and pins allocation are shown below for I2C, UART, CAN and SPI:

#### Table 7: I2C pin assignment

Description	Pin	Wire Gauge
I2C_SDA	1	26 AWG
I2C_SCL	2	26 AWG
GND	3	26 AWG

#### Table 8: SPI pin assignment

Description	Pin	Wire Gauge
SPI_SEL	1	26 AWG
SPI_CLK	2	26 AWG
SPI_MISO	3	26 AWG
SPI_MOSI	4	26 AWG

#### Table 9: CAN pin assignment

Description	Pin	Wire Gauge
CAN_H	1	26 AWG
CAN_L	2	26 AWG

#### Table 10: UART pin assignment

Description	Pin	Wire Gauge
UART_TX	1	26 AWG
UART_RX	2	26 AWG



### 4.4 Data storage

The on-board computer will provide 30 GB storage in SD card for payload data. On the other hand, the payload can store its data in the payload subsystem and download it directly to the ground station during payload scheduled passes.

## 4.5 RF Interface

PHI platform provides two communication subsystems to uplink tele-commands and download telemetries and payload data to the ground station:

- UHF-VHF communication subsystem
- S- band communication subsystem

The main transceiver for telemetry downloads and tele-command uploads during LEOP is a full duplex UHF downlink VHF uplink transceiver consisting of a UHF transmitter and a VHF receiver developed inhouse. The main UHF/VHF transceiver is designed to transmit and receive at 9.6kbps. The S-band transceiver will be used to downlink large size data and uplink software files and tele-commands. Table (11) and Table (12) shows the specifications of the communication subsystems:

Table	11:	UHF-VHF	specifications

Specifications	Value
UHF Downlink Frequency	400-440MHz
VHF Uplink Frequency	140-150MHz
UHF/VHF Data Rate	9.6kbps
Modulation Scheme	BPSK
Transmission Mode	Full Duplex



Specifications	Value
Downlink Frequency	2230 MHz
Uplink Frequency	2050 MHz
Data Rate	2Mbps
Modulation Scheme	QPSK
Transmission Mode	Full Duplex

#### Table 12: S-band specifications

The payload can download about 30 MB per contact using S-band link considering 8 min contact time. The payload can be connected to S-band.

### 4.6 Mechanical Interface

PHI platform is a 12U structure designed by MBRSC following CubeSat standard size and volume.

- X and Y dimensions (mm): 246.3  $\pm$  0.1
- Z dimension (mm): 340.5 ± 0.3

The platform provides around 5U equivalent volume to host the payload with its harness and a mass that should not exceed 5 kg.





#### Figure 3: Payload 5U volume

The mechanical structure is designed to host the payload in both forms electronic PCB and mechanical box. The electronic PCB should follow CubeSat PCB Dimension: 95.5 mm \* 90.17 mm. The stackable approach uses PC/104 connectors that are placed on the subsystem boards, and the subsystem boards connect to each other. PHI platform provides extra volume in the stacking structure. Figure (4) and Figure (5) shows the reserved location and height for payload PCB. The dimensions of the PCB with the location of mounting holes and stacking connector presented in detail in Figure (6).





Figure 4: Payload PCB reserved location



Figure 5: Payload PCB reserved max height.





Figure 6: PCB MICD

In case the payload has a customized PCB design, the hosted payload can customize the mechanical support and bracket for their PCBs to be placed anywhere in the 5U provided volume. Figure (7) and Figure (8) show the mechanical structure frame with the mounting holes locations. It indicates the pattern that the hosted payload should follow in designing the customized PCBs or payload boxes otherwise the payload should design a bracket to interface between the platform mechanical structure and their boxes.





Figure 7: Payload box interface



Figure 8: Structure wall MICD



## 4.7 Thermal Interface

The platform thermal design is highly affected by the orbit parameters, payload selected and operations that vary based on the mission. The satellite consists of passive and active thermal control. The platform can provide thermal insulation or a heat path for the payload to maintain the temperature within acceptable range. External heaters will be provided by PHI platform if needed which requires customization of heaters based on the power consumption. The platform will control the external payload heater by switching them ON/OFF using hardware or software control. The platform can provide two flexible heaters for the payload if needed. If the payload includes its own internal heaters as part of their subsystem, the power and control of the heaters should be managed within the payload. In addition, the platform can provide four reserved analog thermistors that can be allocated in the outer structure of the payload to read the temperature telemetries by OBC.

## 4.8 Attitude Control System Interface

ADCS uses priority-based pointing for its operation as the user can set the priorities. The ADCS provide different pointing modes depending on the mission and payload requirements. More details are presented in Table (13).

Specifications	Value
Attitude Precision	Achieve a pointing accuracy of ±1 degrees
Maneuver performance	80 degrees in 95 seconds
Pointing modes	<ul> <li>Sun pointing</li> </ul>
	<ul> <li>Nadir pointing</li> </ul>
	<ul> <li>Target tracking</li> </ul>
Standalone flight control software	The flight software is running on its own ADCS
	board and not part of the main OBC
Used hardware	<ul> <li>ADCS board</li> </ul>
	<ul> <li>Reaction wheels</li> </ul>
	<ul> <li>Magnetic torque rods</li> </ul>
	<ul> <li>Sun sensors</li> </ul>
	<ul> <li>Gyroscopes</li> </ul>
	<ul> <li>Magnetometers</li> </ul>
	<ul> <li>GPS</li> </ul>

#### Table 13: ADCS specifications



## **5.0 GROUND STATION**

The ground segment includes the Ground Station Network (GSN) and the Mission Operation Center (MOC). The Ground station is in MBRSC. UHF band will be used for downloading telemetries while the VHF band will be used for uplink the telecommands. The S band network will be used to download the payload data and upload large files. The payload operators can be at MBRSC during payload operation or can have remote access during payload operation to monitor and operate the payload. MBRSC operation team will schedule the contacts over specified ground stations and define the payload data including whole orbit data will be downloaded, stored, and provided to payload team by MBRSC team, payload team will be responsible for processing and analyzing their data. MBRSC will provide a customized dashboard to view payload real time telemetry if there is a payload operation during the contact. More details about operation will be discussed with the selected payload later.





Figure 9: Ground station diagram



## 6.0 SAFETY AND QUALITY

## 6.1 Safety

Safety and quality of the payload require planning and controlling to avoid mission failure. One of the recommended approaches is Preliminary Hazard Analysis (PHA). It is one of the essential cornerstones of health and safety management systems for any mission. By following a systematic approach, hazards can be identified and managed, so people are not harmed in the course of their work. Moreover, implementing such an approach will help in preserving the facility, environment, and the project. PHA can identify any hazards in the payload that will affect the S/C and its operation.

## 6.2 Material

The below are some aspects for evaluating materials in accordance with their relevance application:

1) Outgassing:

Every non-metallic material that is not hermetically sealed shall be assessed based on its outgassing acceptance criteria:

- Total Mass Loss (TML) ≤ 1%
- Collected Volatile Condensable Materials (CVCM) ≤ 0.1%
- 2) Flammability

Evaluation of materials flammability shall be done especially to materials that are used in hazardous environment during satellite launch or storage as examples. Flammable materials are to be avoided when possible.

3) Resistance to thermal cycling

All materials shall be assessed if they have thermal degradation in performance or possible cracks after exposure to long cyclic stresses included in thermal cycling or TVAC tests.

4) Resistance to radiation:



All materials which are located on the external surface of the satellite including but not limited to; thermal blankets, thermal insulation systems and thermal paints shall be evaluated to check if any performance degradation can occur once exposed to radiation. The evaluation shall include the assessment of particle and ultraviolet radiation if needed and according to the expected radiation levels during the mission lifecycle.

5) Vacuum:

Materials shall be assessed if they will cause any problems under vacuum conditions. Mainly, vacuum conditions can increase the outgassing of certain organic materials used.

6) Stress Corrosion Cracking (SCC):

Materials used in structural applications shall always be screened to prevent failures resulting from SCC. Also, these materials shall endure long term storage and environmental testing exposed on the satellite.